

Silicon Carbide MOSFET 1200V, 50m Ω

General Description

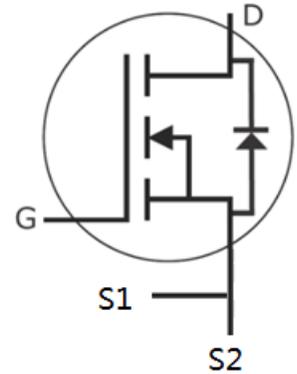
This product family offers state of the art performance. It is designed for high frequency applications here high efficiency and high reliability are required.

Features

- High voltage, low on resistance
- High speed, low parasitic capacitance
- High junction temperature
- Fast recovery diode
- Kelvin connection driver



T0-247-4L



S1: Driver Source
S2: Power Source

Applications

- motor drive
- Photovoltaic inverter
- UPS power supply
- High voltage DC / DC converter
- Switching Mode Power Supply

Key performance parameters

| Type | V_{DS} | I_D $T_C=25^\circ C$ | $R_{DS(ON)}$ |
|------------|----------|---------------------------|--------------|
| NF3M50120K | 1200V | 58A | 50m Ω |

Maximum Ratings

$T_C=25^{\circ}\text{C}$, unless otherwise specified

| Parameter | Symbol | Value | Unit |
|--|----------|----------|------|
| Drain-source voltage $V_{GS} = 0\text{V}$, $I_D = 100 \mu\text{A}$ | V_{DS} | 1200 | V |
| Gate-source voltage Recommended maximum | V_{GS} | -5 to 20 | V |

Maximum Ratings

$T_C=25^{\circ}\text{C}$, unless otherwise specified

| Parameter | Symbol | Value | Unit |
|--|-----------|-------------|--------------------|
| Continuous drain current : $V_{GS} = 20\text{V}$ $T_C = 25^{\circ}\text{C}$ $T_C = 100^{\circ}\text{C}$ | I_D | 58 43 | A |
| Pulsed drain current: Pulse width limited by SOA | I_{DM} | 145 | A |
| Power dissipation : $T_C = 25^{\circ}\text{C}$ | P_{TOT} | 344 | W |
| Storage temperature range : | T_{stg} | -55 to +175 | $^{\circ}\text{C}$ |
| Operating and junction temperature: | T_j | -55 to +175 | $^{\circ}\text{C}$ |
| Soldre temperature: Wave soldering only allowed at leads, 1.6 mm from case for 10 s | T_L | 260 | $^{\circ}\text{C}$ |

Thermal Resistance

| Parameter | Symbol | Typ. | Unit |
|-----------------------------|------------|-------|-----------------------------|
| Thermal resistance to shell | R_{thJC} | 0.436 | $^{\circ}\text{C}/\text{W}$ |

Electrical Characteristic
 $T_C = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Value | | | Unit | Test Condition |
|------------------------------------|--------------------|-------|------------|-----------|------------------|---|
| | | Min. | Typ. | Max. | | |
| Zero gate voltage drain current | I_{DSS} | | 5 | 100 | μA | $V_{DS} = 1200\text{V}$ $V_{GS} = 0\text{V}$ |
| Gate leakage current | I_{GSS} | | 1 | ± 100 | nA | $V_{DS} = 0\text{V}$ $V_{GS} = -5\sim 20\text{V}$ |
| Gate threshold voltage | V_{TH} | | 3.2 2.2 | | V | $V_{GS} = V_{DS}$ $I_D = 6\text{mA}$ $T_C = 175^\circ\text{C}$ |
| Drain-source on-state resistance | R_{ON} | | 50 80 | 65 | $\text{m}\Omega$ | $V_{GS} = 20\text{V}$ $I_D = 20\text{A}$ $T_J = 25^\circ\text{C}$ $T_J = 175^\circ\text{C}$ |
| Input capacitance | C_{iss} | | 2750 | | pF | $V_{DS} = 800\text{V}$ $V_{GS} = 0\text{V}$ $f = 1\text{MHz}$ $V_{AC} = 25\text{mV}$ |
| Output capacitance | C_{oss} | | 106 | | | |
| Reverse transfer capacitance | C_{rss} | | 5.2 | | | |
| The output capacitor stores energy | E_{oss} | | 43 | | μJ | |
| Total gate charge | Q_g | | 120 | | nC | $V_{DS} = 800\text{V}$ $I_D = 20\text{A}$ $V_{GS} = -5\text{ to }20\text{V}$ |
| Gate to source charge | Q_{gs} | | 25 | | | |
| Gate to drain charge | Q_{gd} | | 48 | | | |
| Gate input resistance | R_g | | 2.8 | | Ω | $f = 1\text{MHz}$ |
| Turn-on switching energy | E_{ON} | | 455.4 | | μJ | $V_{DS} = 800\text{V}$, $I_D = 30\text{A}$, $V_{GS} = -2\text{ to }20\text{V}$, $R_{G(\text{ext})} = 3.3\Omega$, $L = 450\mu\text{H}$ |
| Turn-off switching energy | E_{OFF} | | 213.6 | | μJ | |
| Turn-on delay time | $t_{d(\text{on})}$ | | 8.9 | | ns | |
| Rise time | t_r | | 28.9 | | | |

| | | | | | | |
|---------------------|--------------|--|------|--|--|--|
| Turn-off delay time | $t_{d(off)}$ | | 25.6 | | | |
| Fall time | t_f | | 17.2 | | | |

Reverse Diode Characteristics

$T_c = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Value | | | Unit | Test Condition |
|-------------------------------|-----------|-------|------------|------|------|---|
| | | Min. | Typ. | Max. | | |
| Diode forward voltage | V_{SD} | | 4.9 4.4 | | V | $I_{SD} = 20\text{A}$ $V_{GS} = 0\text{V}$ $T_J = 175^\circ\text{C}$ |
| Reverse recovery time | t_{rr} | | 44.4 | | ns | $V_{GS} = -2\text{V}/+20\text{V}$, $I_{SD} = 30\text{A}$, $V_R = 800\text{V}$, $di/dt = 1000\text{A}/\mu\text{s}$, $R_{G(ext)} = 10\ \Omega$ $L = 450\ \mu\text{H}$ |
| Reverse recovery charge | Q_{rr} | | 212.6 | | nC | |
| Reverse recovery peak current | I_{RRM} | | 10.8 | | A | |

Characteristics Curves

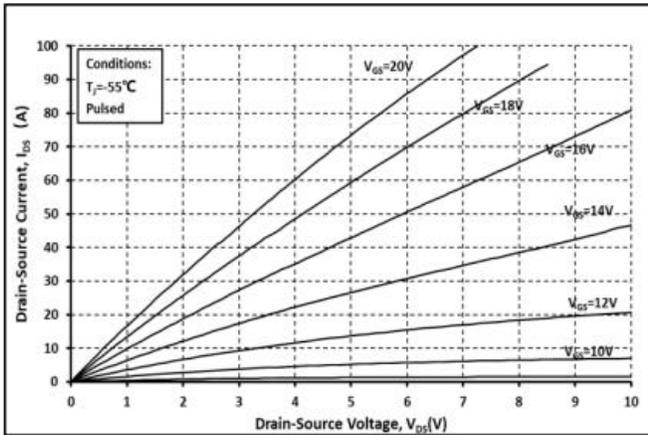


图. 1 输出曲线 @ $T_j = -55^\circ\text{C}$

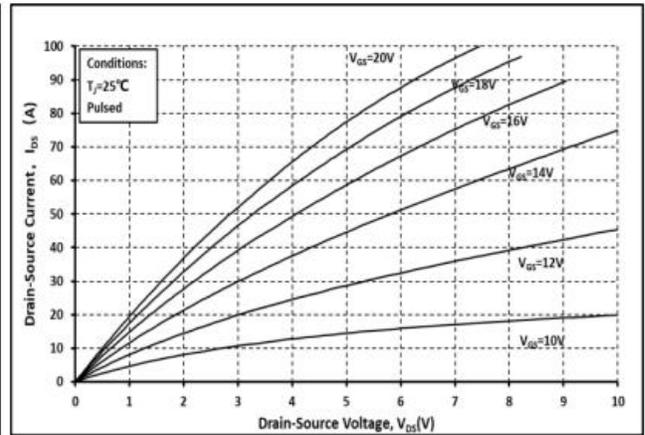


图. 2 输出曲线 @ $T_j = 25^\circ\text{C}$

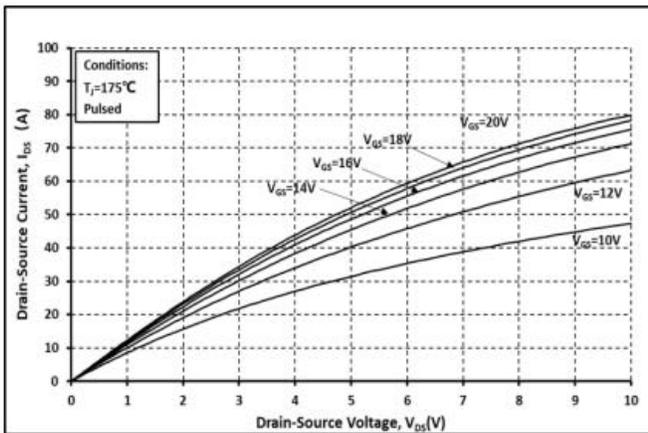


图. 3 输出曲线 @ $T_j = 175^\circ\text{C}$

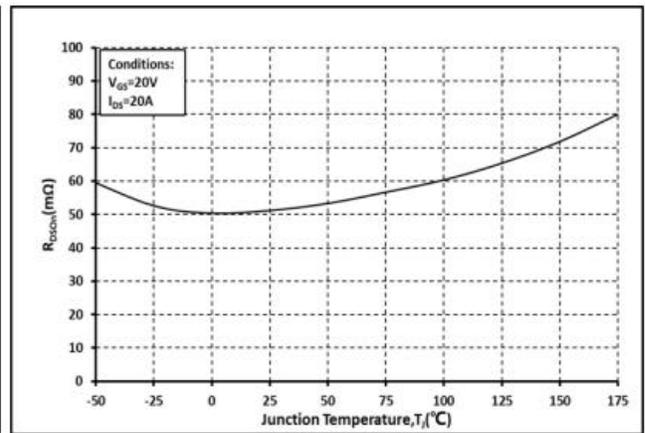


图. 4 R_{on} 和温度关系曲线

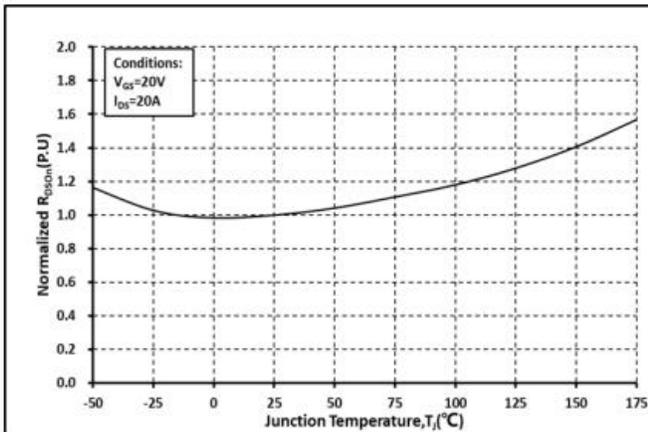


图. 5 归一化的 R_{on} 和温度关系曲线

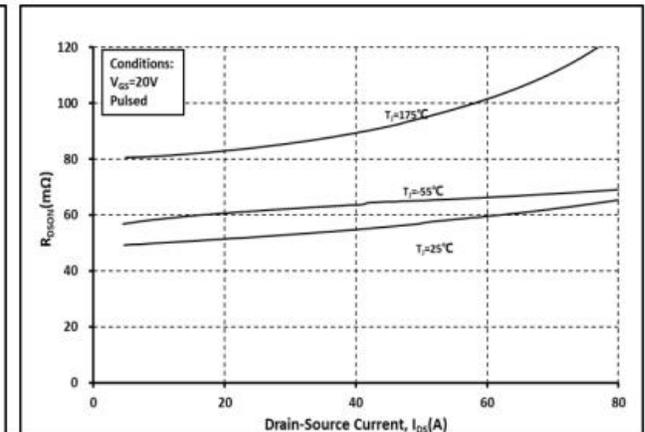


图. 6 各温度下的 R_{on} 和 I_{DS} 关系曲线

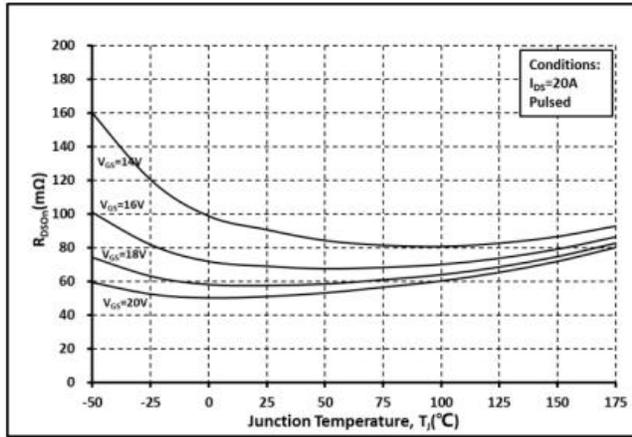


图. 7 各 V_{GS} 下的 R_{on} 和温度关系曲线

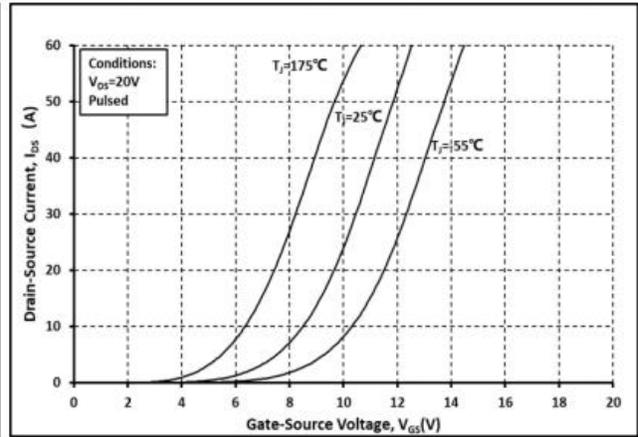


图. 8 各温度下的传输特性曲线

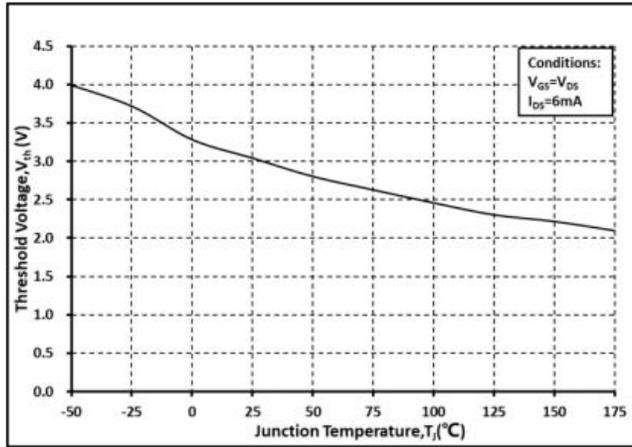


图. 9 阈值电压随温度变化曲线

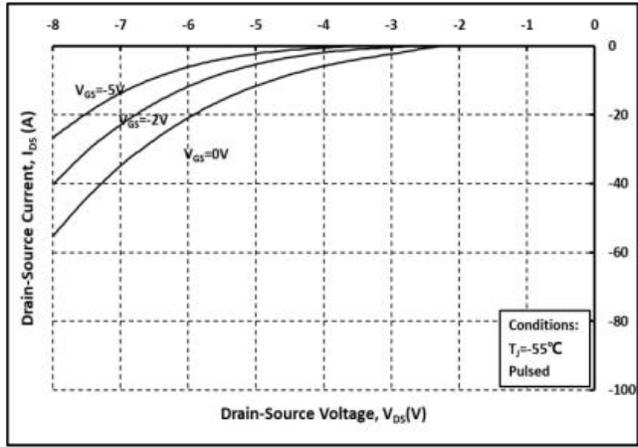


图. 10 体二极管导通曲线 @ $T_j = -55^\circ\text{C}$

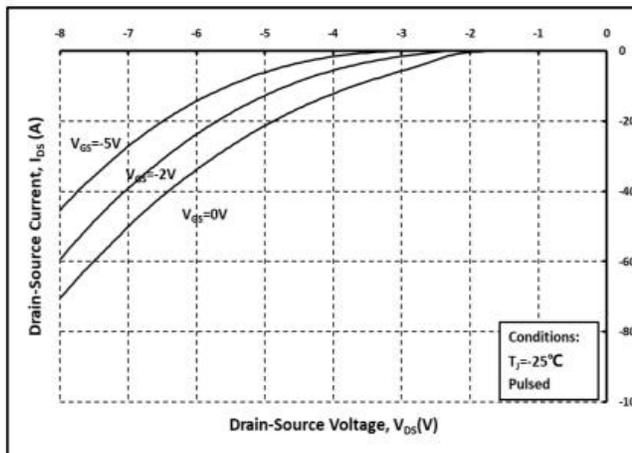


图. 11 体二极管导通曲线 @ $T_j = 25^\circ\text{C}$

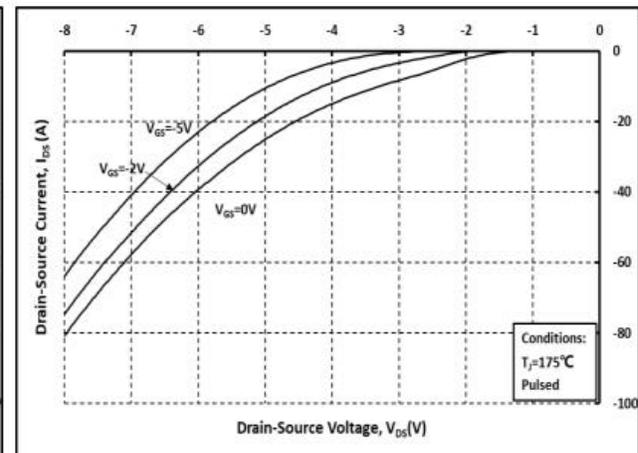


图. 12 体二极管导通曲线 @ $T_j = 175^\circ\text{C}$

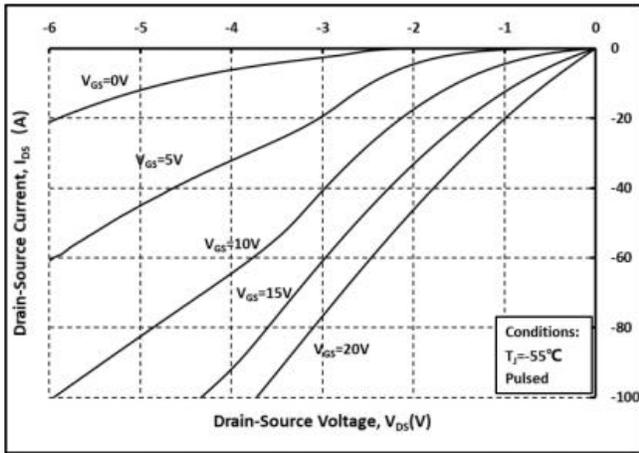


图. 13 第三象限曲线 @ $T_j = -55^\circ\text{C}$

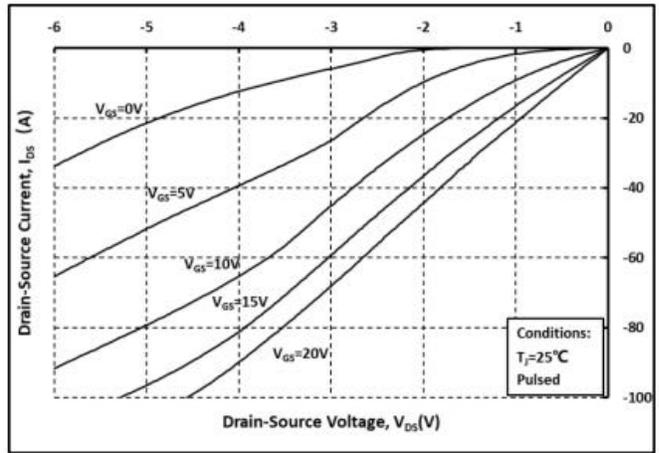


图. 14 第三象限曲线 @ $T_j = 25^\circ\text{C}$

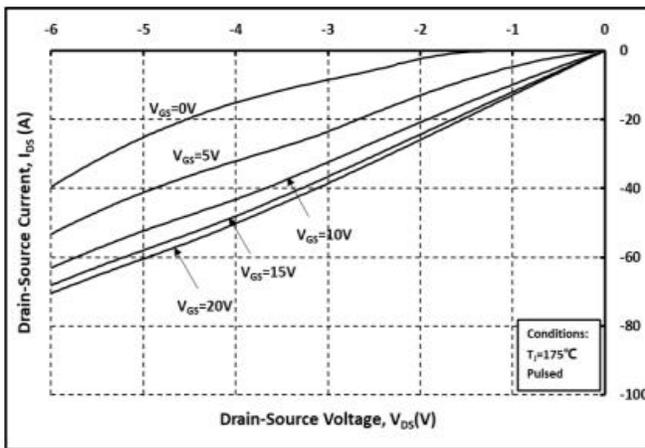


图. 15 第三象限曲线 @ $T_j = 175^\circ\text{C}$

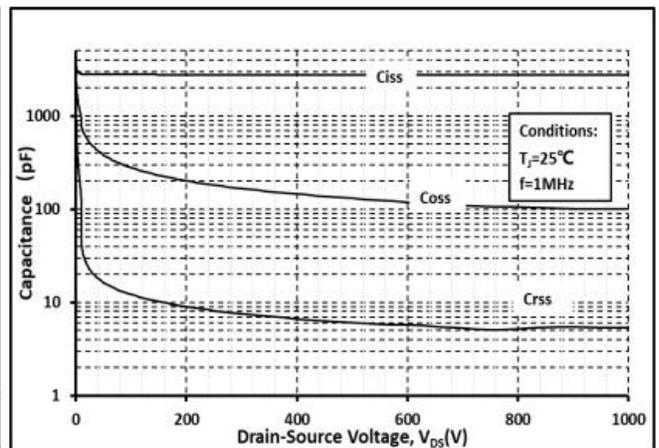


图. 16 各电容和 V_{DS} 关系曲线

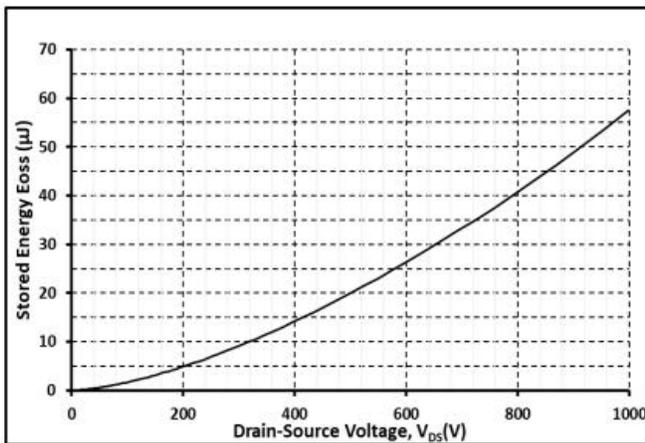


图. 17 输出电容存储能量曲线

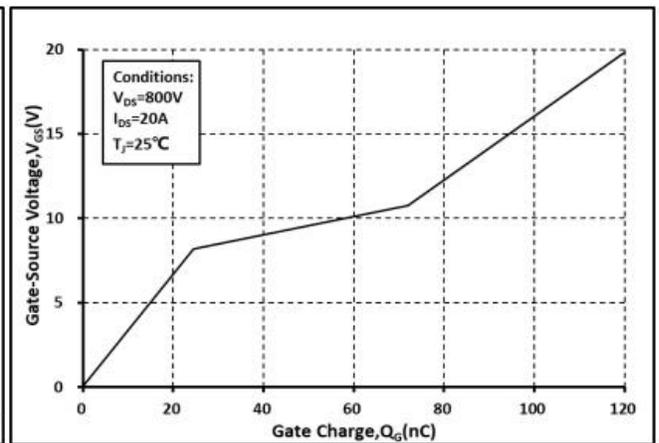


图. 18 栅电荷特征曲线

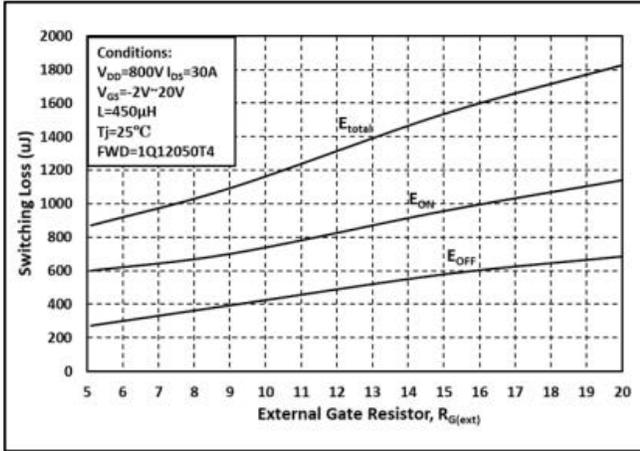


图. 19 开关能量和栅极电阻 $R_{G(ext)}$ 关系曲线

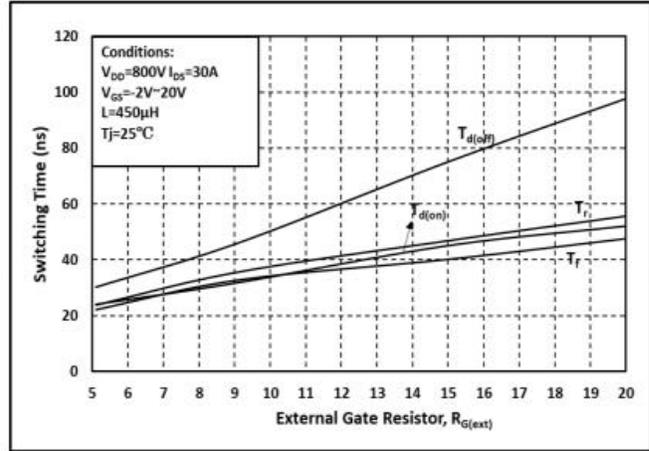


图. 20 开关时间和栅极电阻 $R_{G(ext)}$ 关系曲线

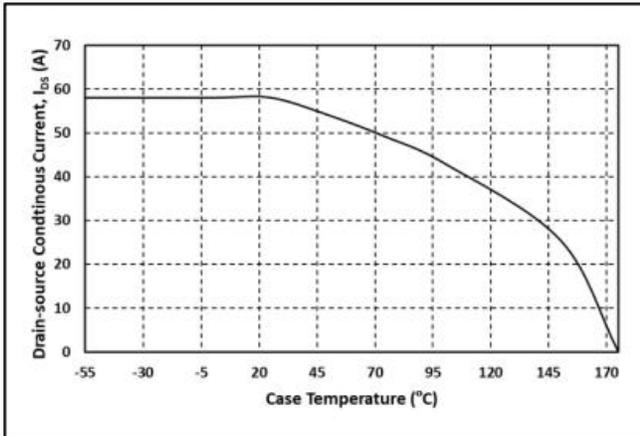


图. 21 漏端电流和温度关系曲线

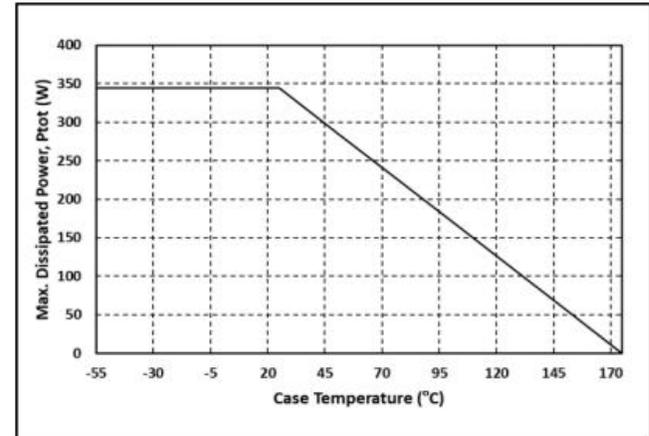


图. 22 最大功耗降额和温度关系曲线

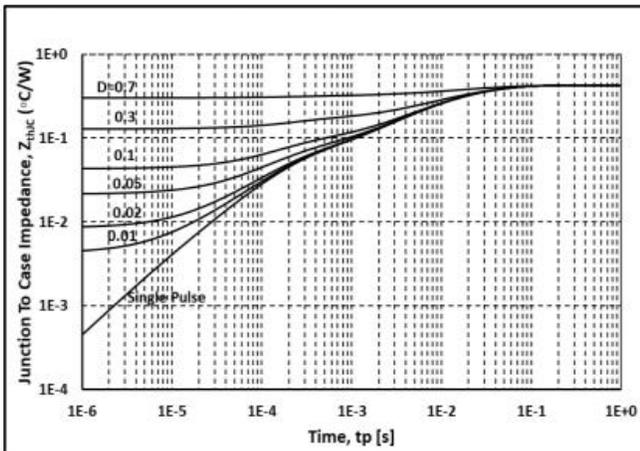


图. 23 热阻曲线

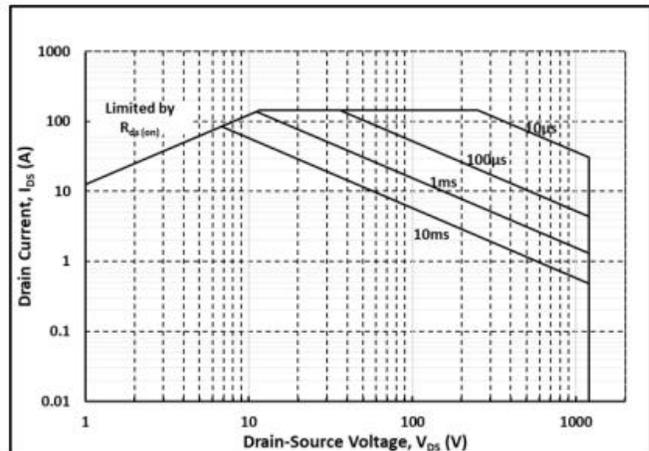


图. 24 安全工作区示意图

